

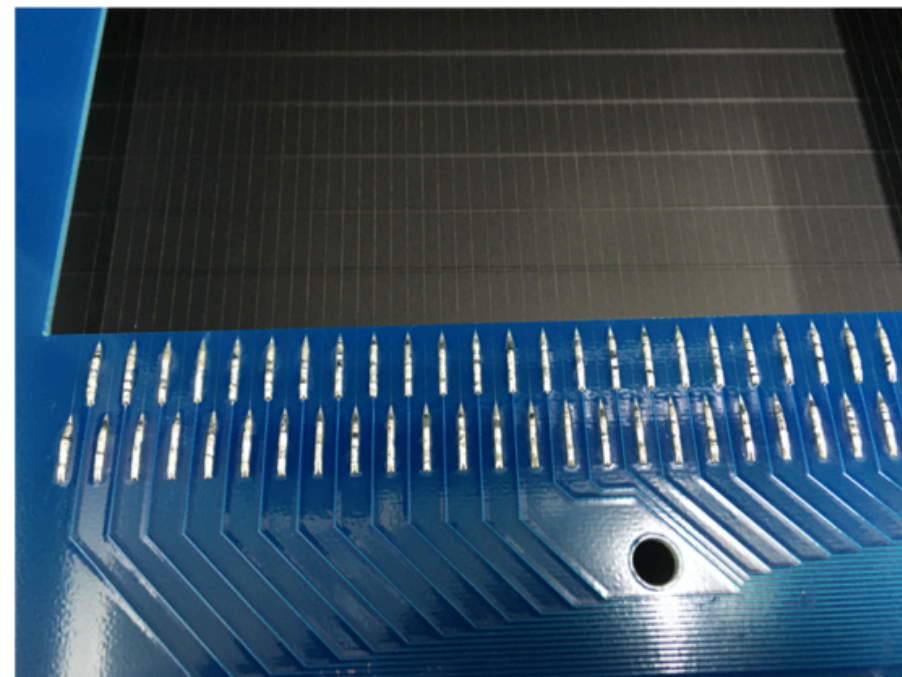
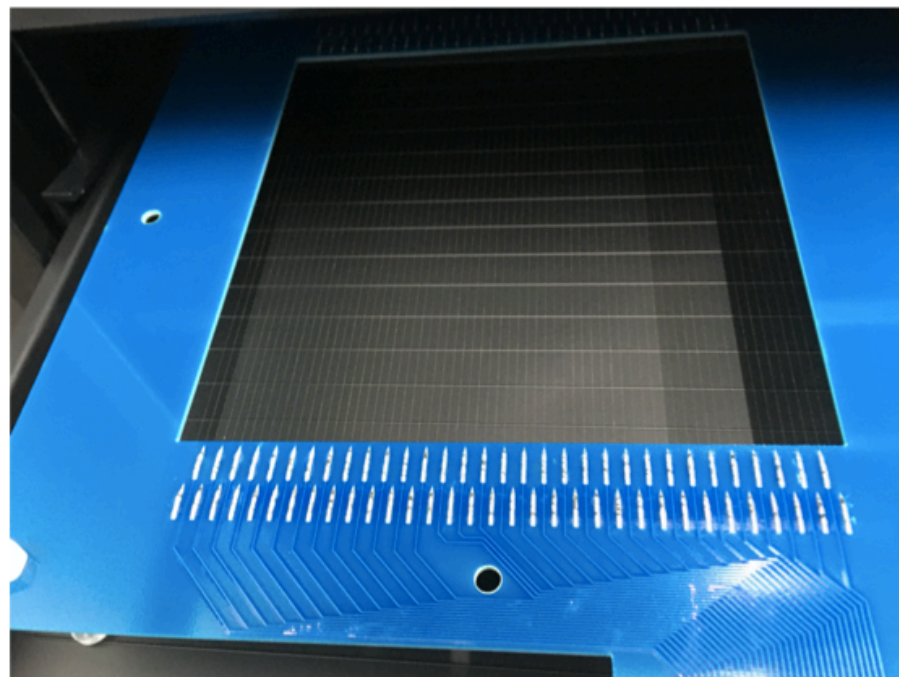
# Status of the BDC production for LAMPS

Hyunchul Kim, Dong Ho Moon, Jaein Hwang, Piljun Gwak,  
Seonghak Lee,  
(Chonnam National University)  
Sanghoon Hwang  
(KRISS)

***LAMPS Workshop***  
***Aug. 13<sup>th</sup> – 14<sup>th</sup>, Komodo hotel, Gyeongju,***  
***Republic of Korea***

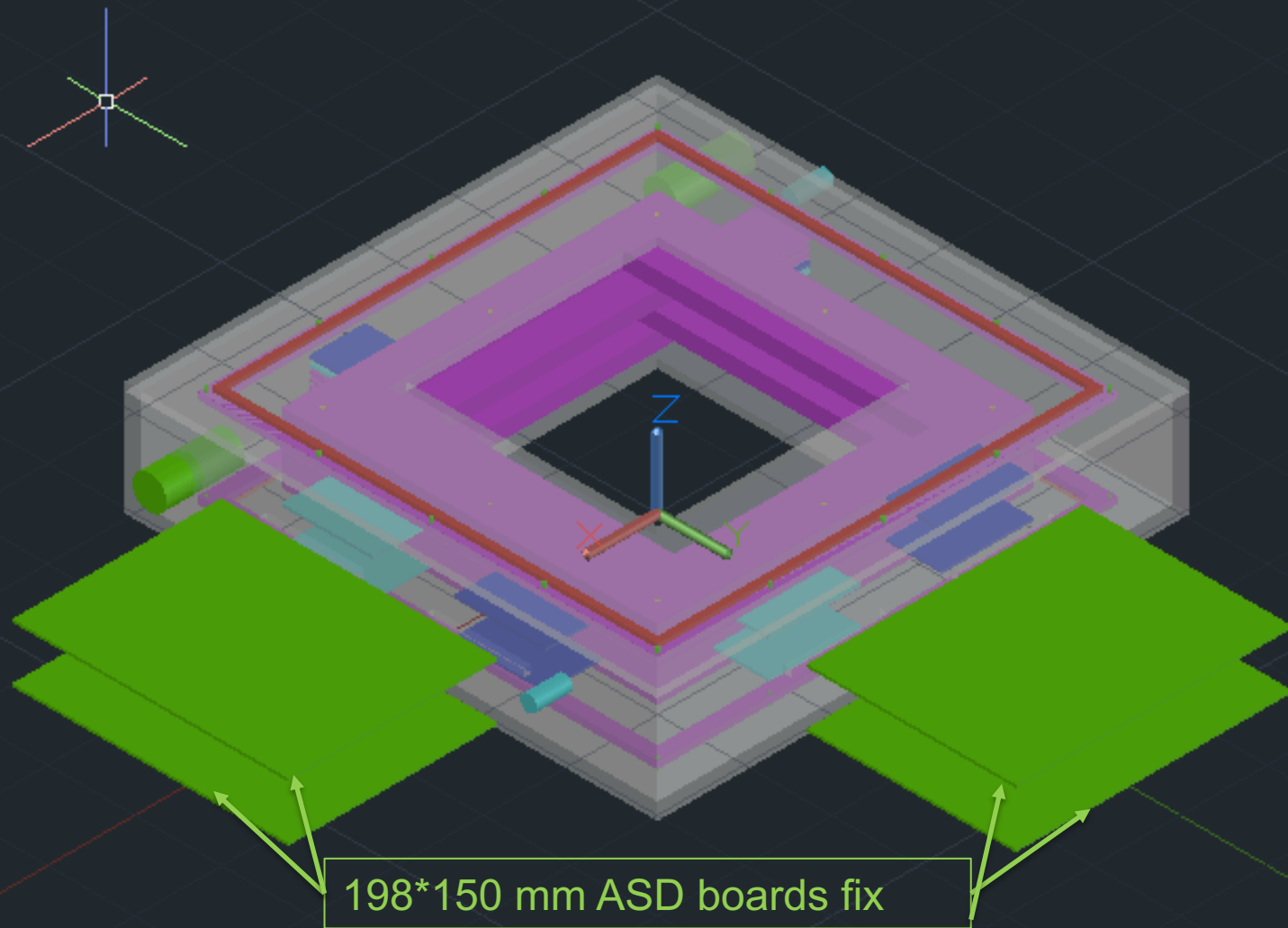
# NEWS – 4 anode plane wiring is done

- Hard work by Jaein and Piljun, with many advice from Sanghoon Hwang (KRISS)
- About 3 weeks for 4 anode planes wiring
- Cleaning is done, waiting for chamber assembly





# BDC design (preliminary)



# Reminder for active area determination

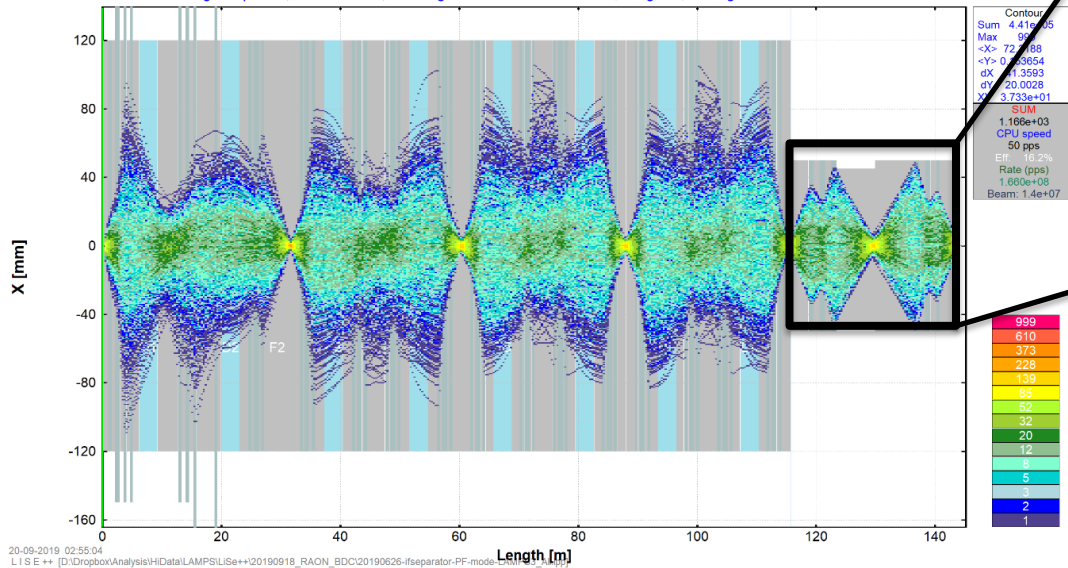
- **Beam study with Lise++**

$^{124}\text{Xe}$  (260 MeV/u) Beam and  $^{14}\text{C}$  target

Isotope Group : MC Yield Plot - Envelope (only passed)

$^{124}\text{Xe}$  (260 MeV/u) + C (2.5 mm); Transmitted Fragment  $^{110}\text{Sn}$  (ProjFrag); Optics Order: 3  
 dp/p=7.56%; Wedges: Al (1800  $\mu\text{m}$ ); Brho(Tm): 4.8435, 4.8435, 4.8435, 4.3111, 3.9277.....

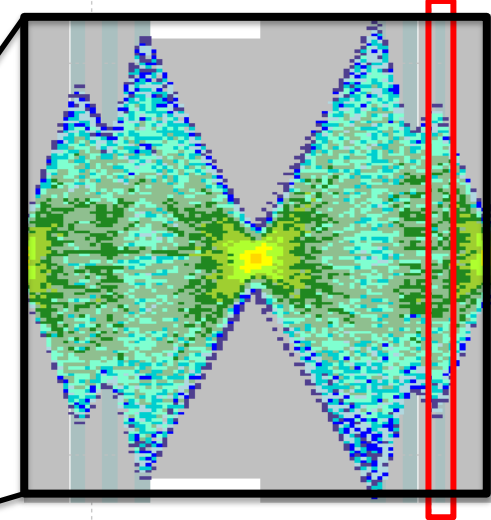
AngAccept: ON; Bounds: ON; "L Target" - last block for MC calc; no gates; Config: SSSSSSSSDSSSSSSSDSSSSSS...



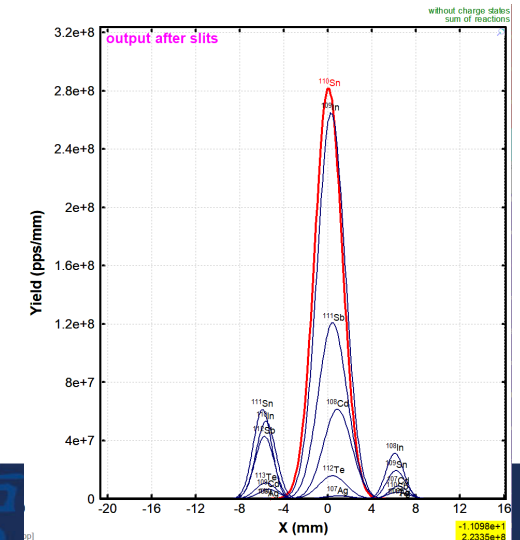
STOP

Contour  
 Sum 4.41e+05  
 Max 592998  
 <X> 72.0188  
 <Y> 0.3854  
 dx 3.9593  
 dy 20.0028  
 X 3.733e+01

SUM  
 1.160e+03  
 CPU speed  
 50 pps  
 El 1.02e+07  
 Rate (pps)  
 1.660e+08  
 Beam: 1.4e+07

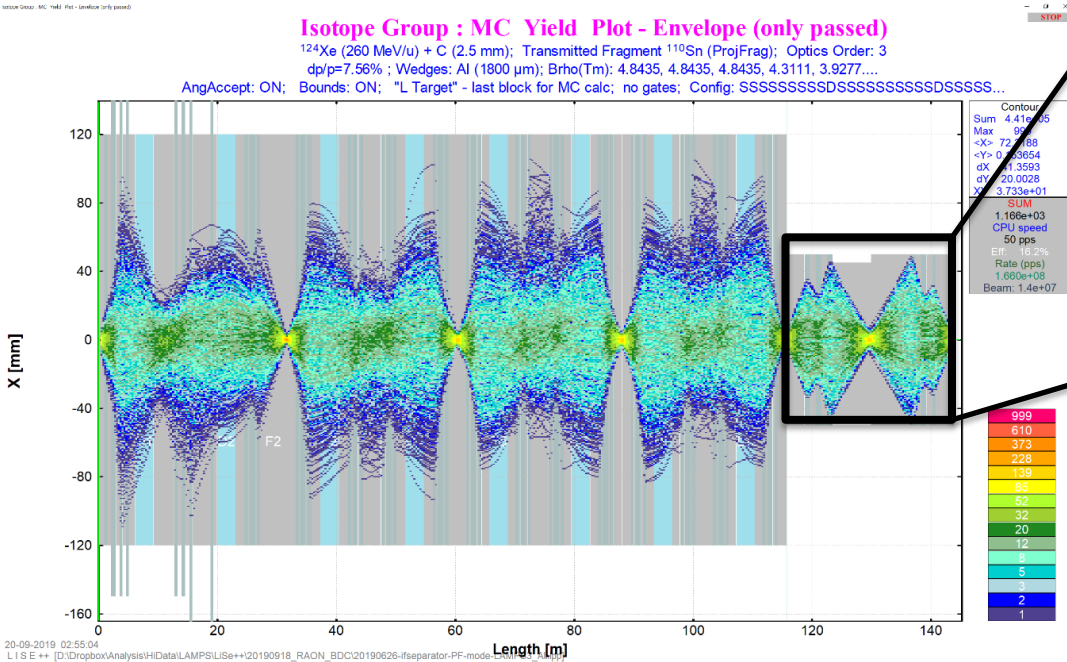


Beam size at L-Target (x)  
 :  $\pm 4.2$  mm

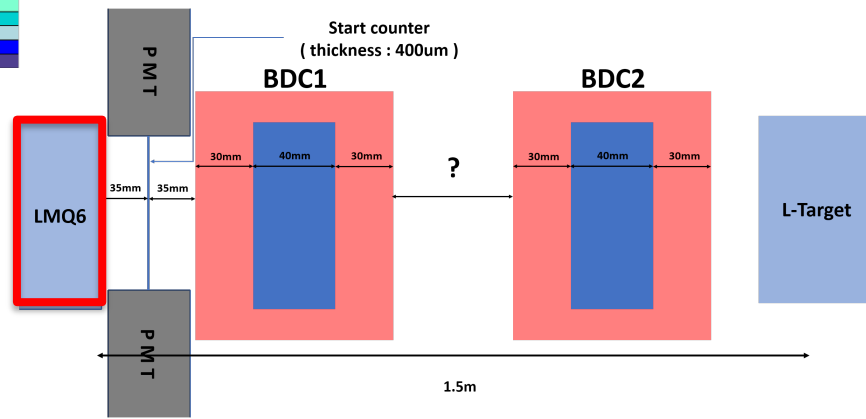


# Reminder for active area determination

- **Beam study with Lise++**  
 $^{124}\text{Xe}$  (260 MeV/u) Beam and  $^{14}\text{C}$  target



Question : estimated beam size at BC position?

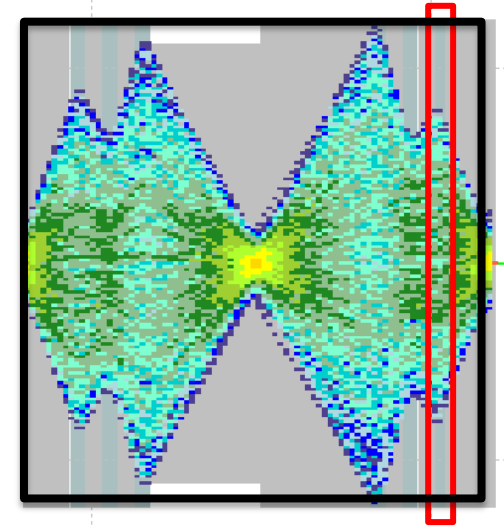
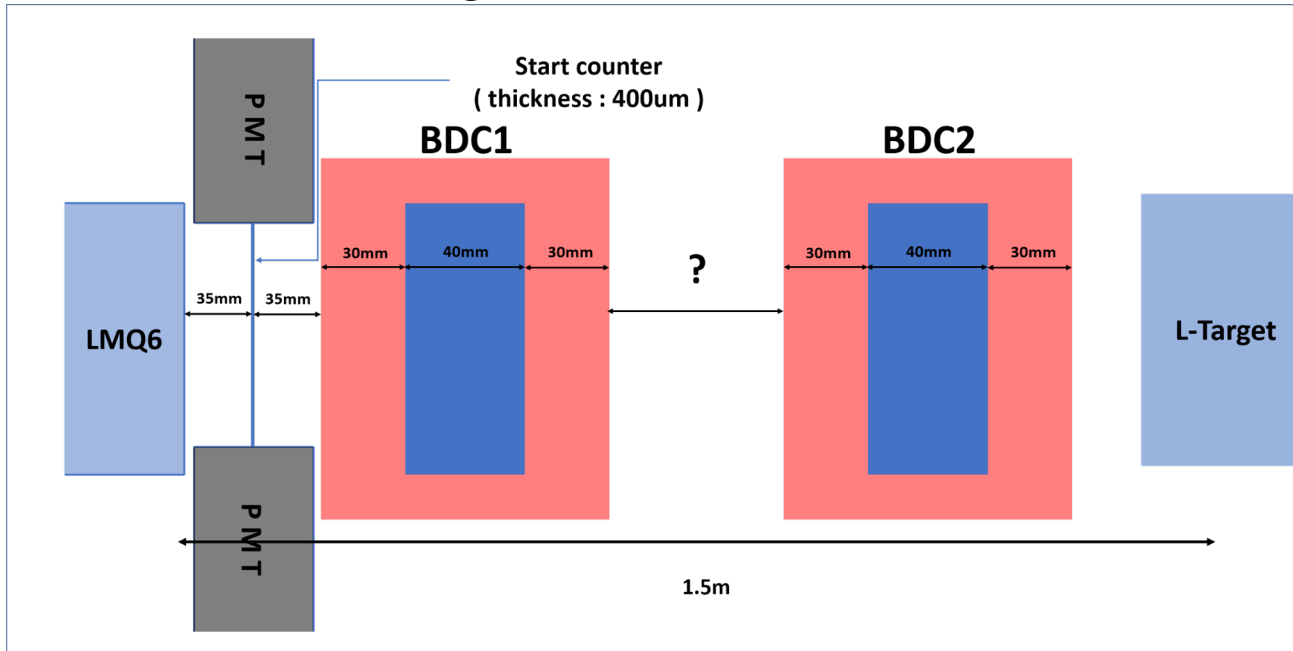


Last quadrupole magnet before BDCs



# Reminder for active area determination

- Beam study with Lise++



- Assumption

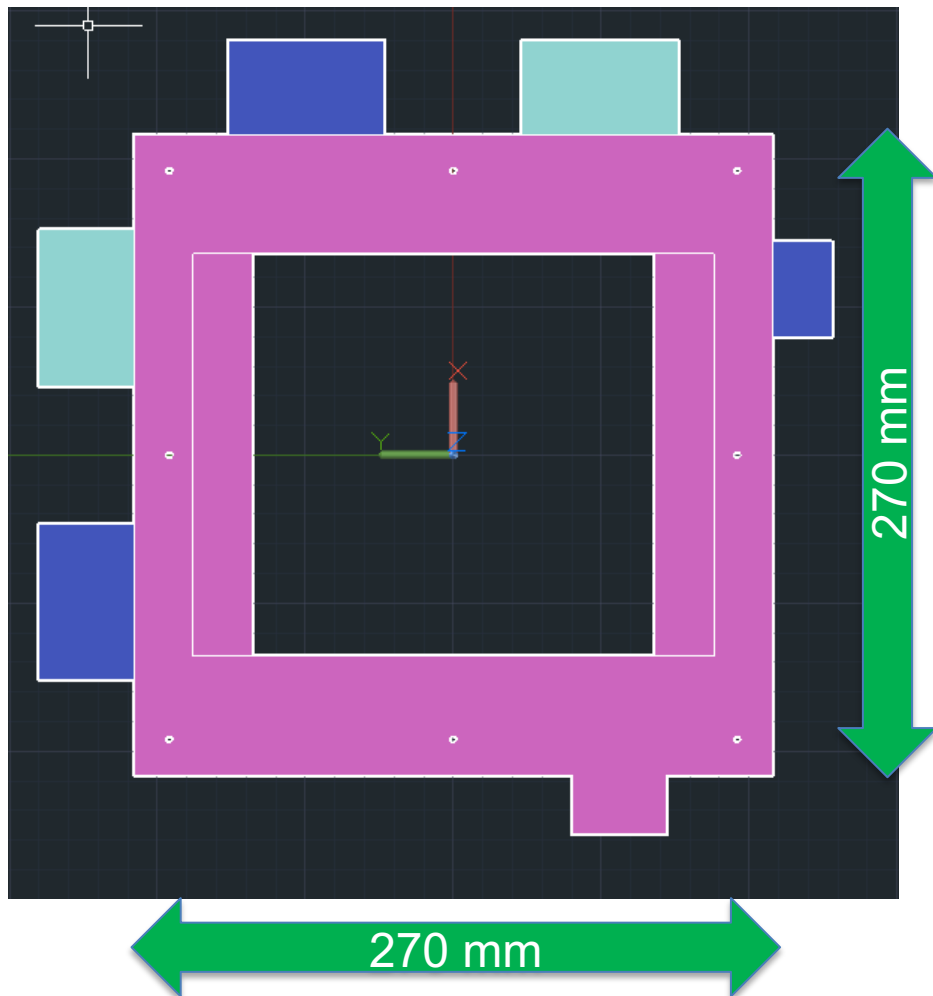
- Start counter doesn't effect much to the beam size (ignorable, except the thickness)
- BDC (active area) is located away from last LMQ6, 100 mm and further







# 프레임 내부 wired planes 사양 (1세트당)

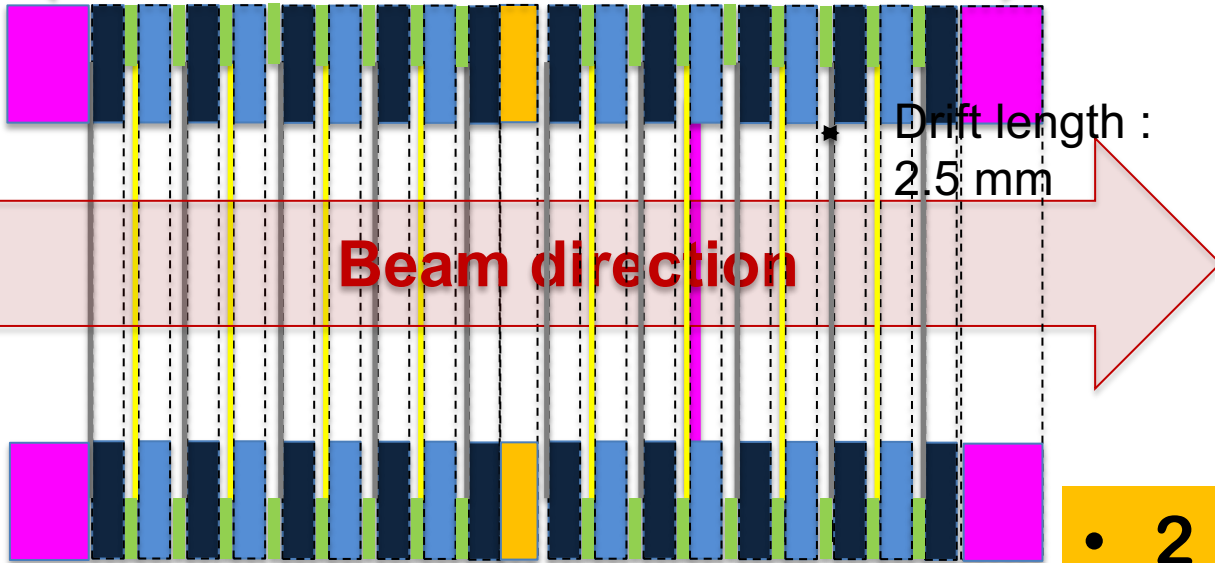


- 2 mm 두께의 wired anode  $(x, x', y, y')$ ,  $(x, x', y, y')$  총 8매
- cathode plane 총 9매 (anode plane 사이)
- 각 anode 와 cathode 사이에 0.5 mm 간격의 spacer 15매, 2 mm 간격의 spacer 3매
- outer frame에 8개의 나사로 고정

# Structure of the chamber

- Cathode plane
- Signal plane
- Mylar (for GND)
- Wire
- Spacer : 0.5 mm
- Middle Spacer : 2 mm
- Thick Spacer : 5 mm

~56 mm

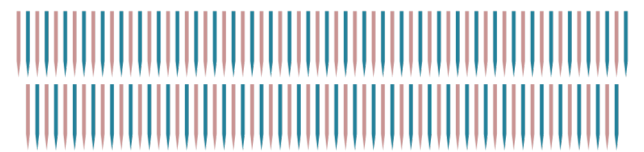


Beam direction

Drift length : 2.5 mm

- 2 points in one set
- Purpose : position resolution of  $100 \mu\text{m}$  (0.1 mm)

x x' y y' x x' y y'



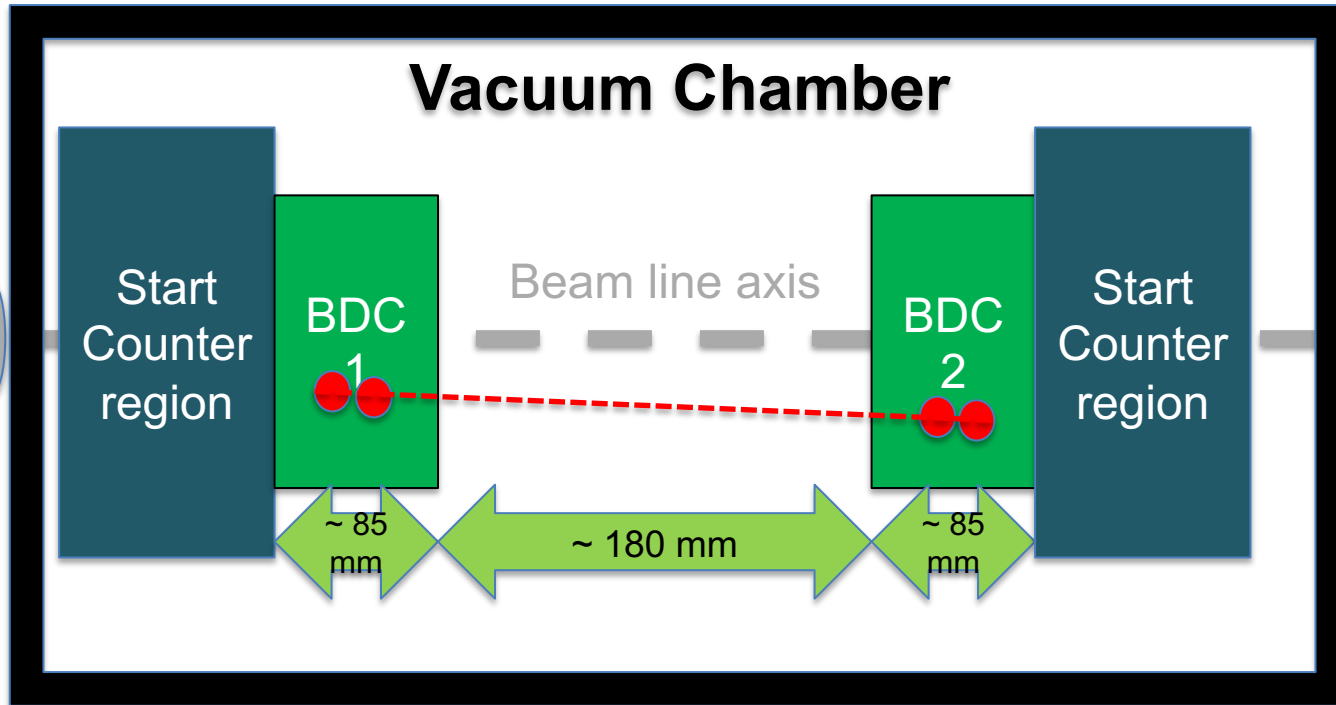
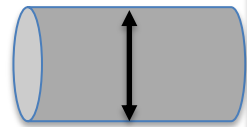
170 mm

xy plane is shifted from x'y' plane with 2.5 mm spacing



# Position of BDC inside the vacuum chamber

Diameter :  
~ 25 cm



Possible area to install BDC :  
Between start counter, range  
of ~ 350 mm

height of beam line axis : 150 cm



# BDC design without chamber (preliminary)

재질

- 시제품 : 알루미늄
- 본제품 : 스테인리스?



# Preliminary design of outer frame

SW Isometric | 2D Wireframe

Type-D feedthrough

SHV-5 feedthrough

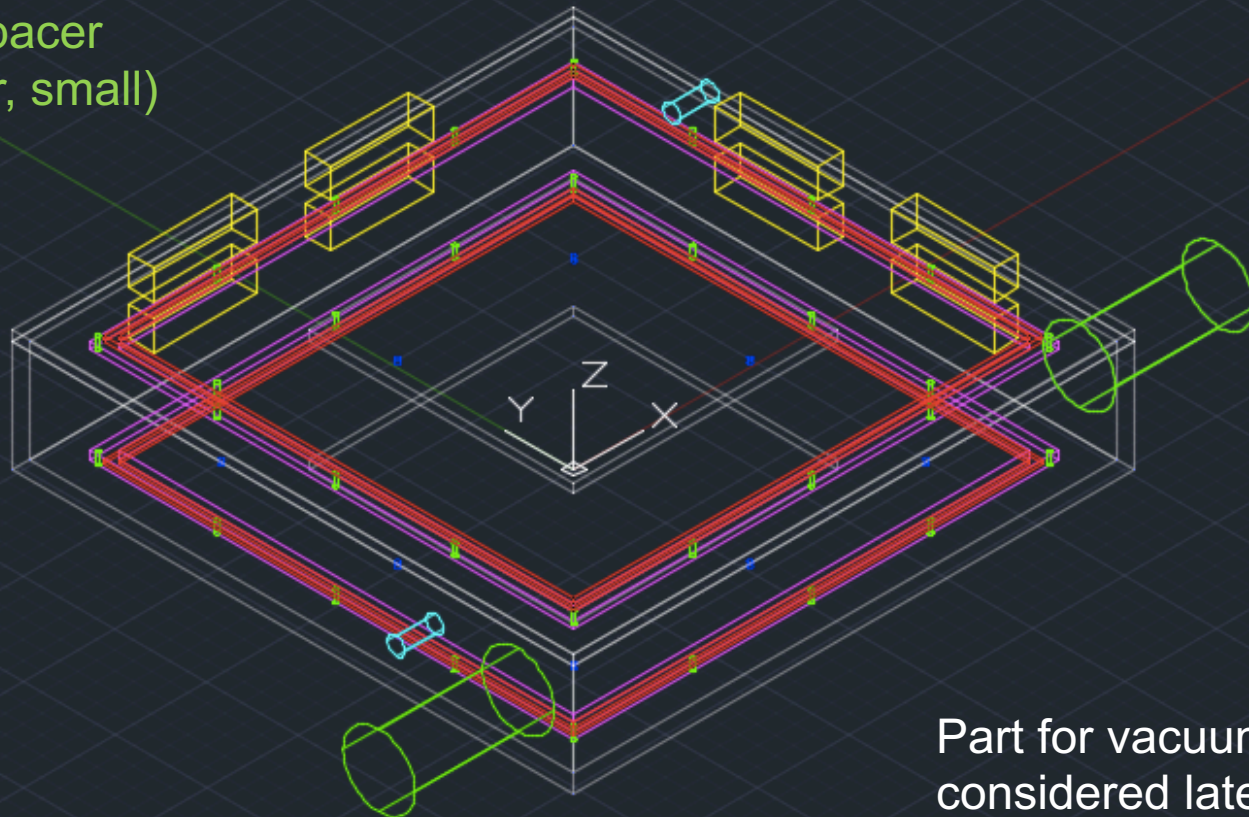
Spacer

Oring

gas in-out let

screws for fix spacer

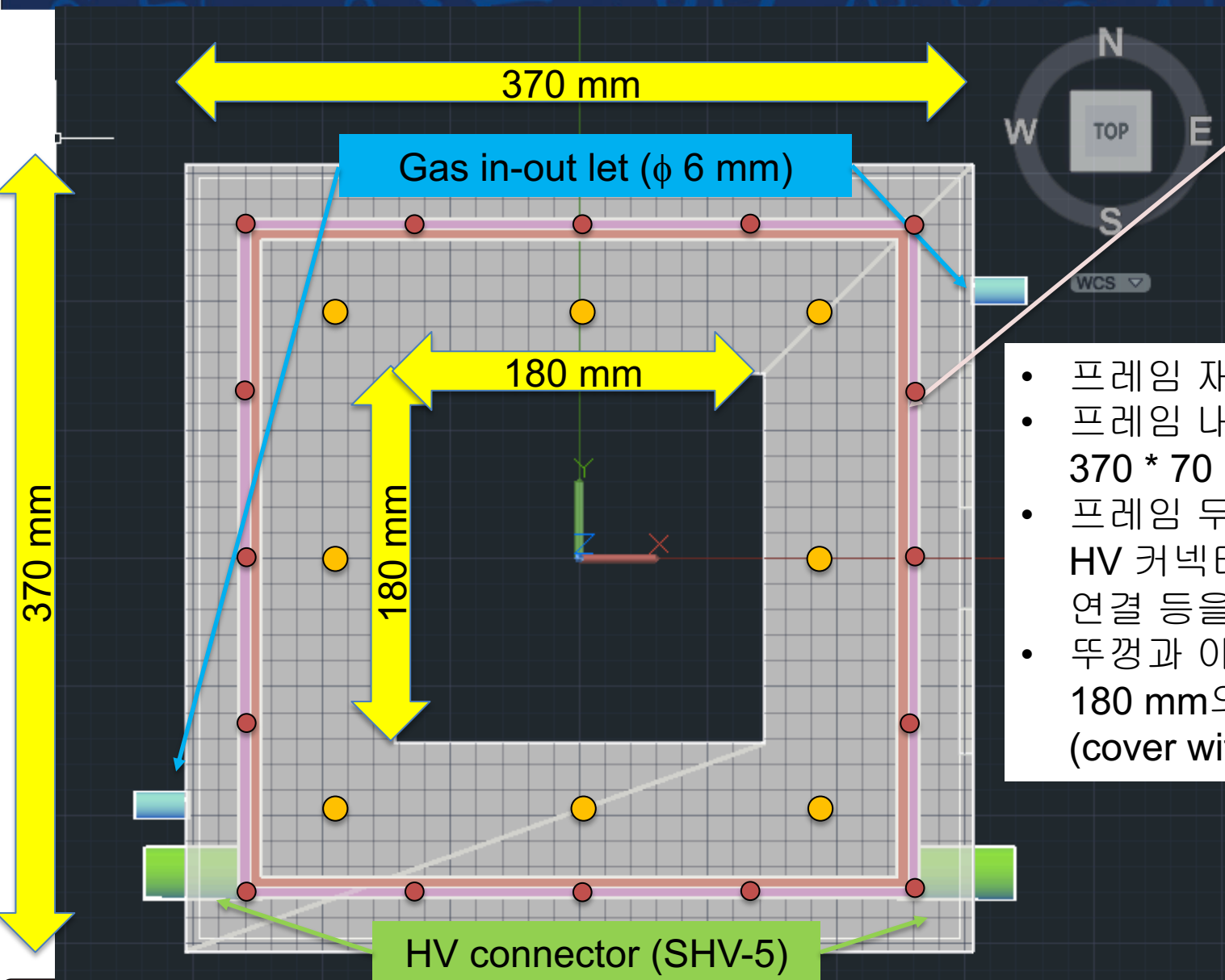
(inside chamber, small)



Part for vacuum will be considered later



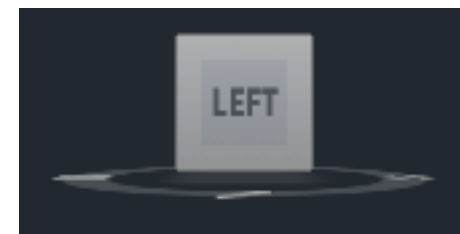
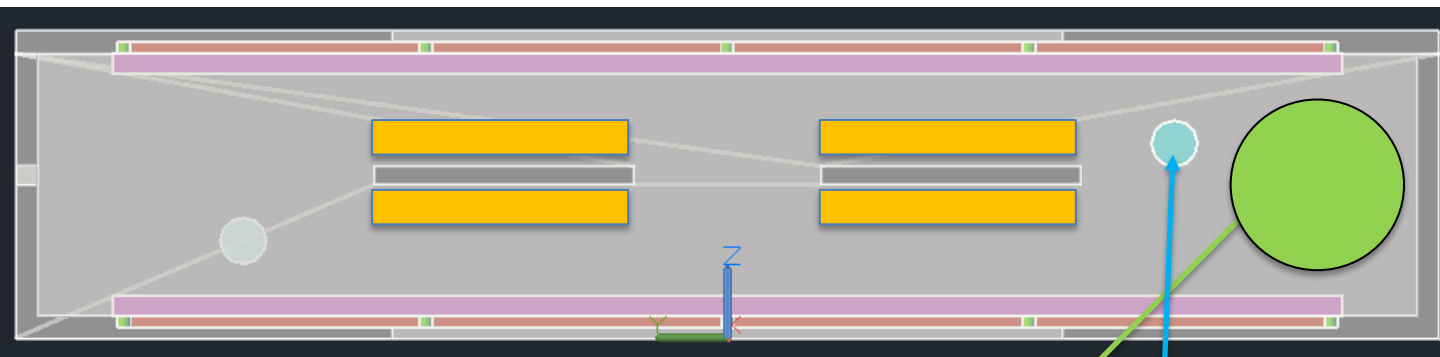
# 뚜껑 위에서 내려다 본 모양



오링과 5T  
두께의  
스페이서

- 프레임 재질 : 알루미늄
- 프레임 내부 규격 : 370 \* 370 \* 70 mm
- 프레임 두께 : 6 mm (단, HV 커넥터, 가스 커넥터 연결 등을 위해 조정 가능)
- 뚜껑과 아래 부분에 180 \* 180 mm의 창을 내야 함 (cover with mylar film?)

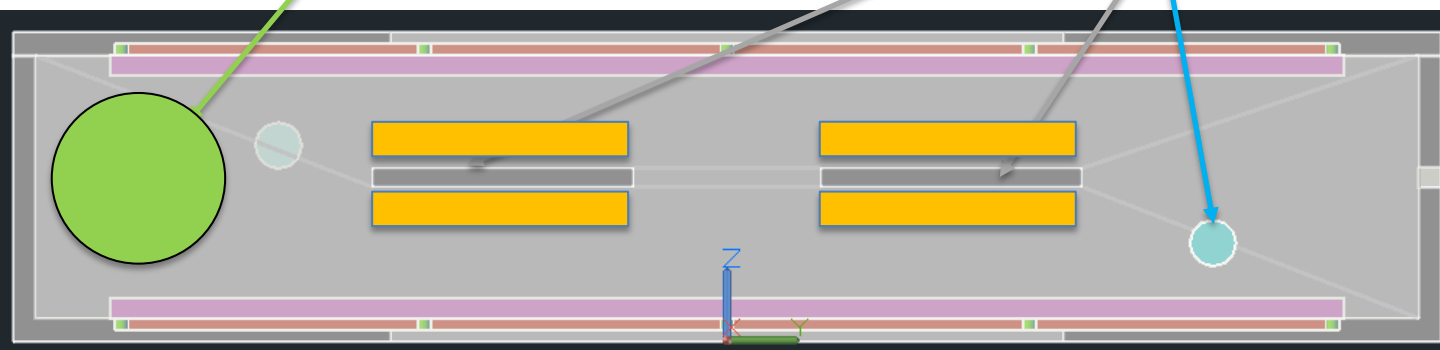
# 측면에서 바라 본 모양 (본제품)



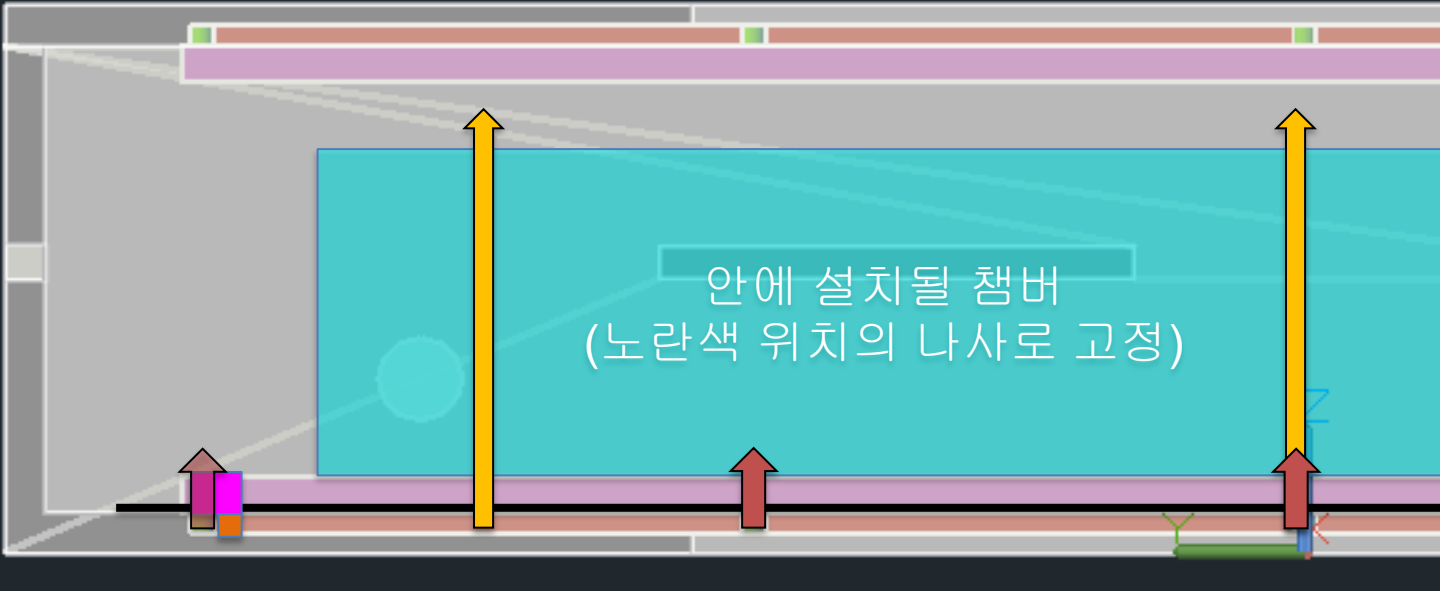
HV connector (SHV-5)  
feedthrough

Gas in-out let ( $\phi$  6 mm)

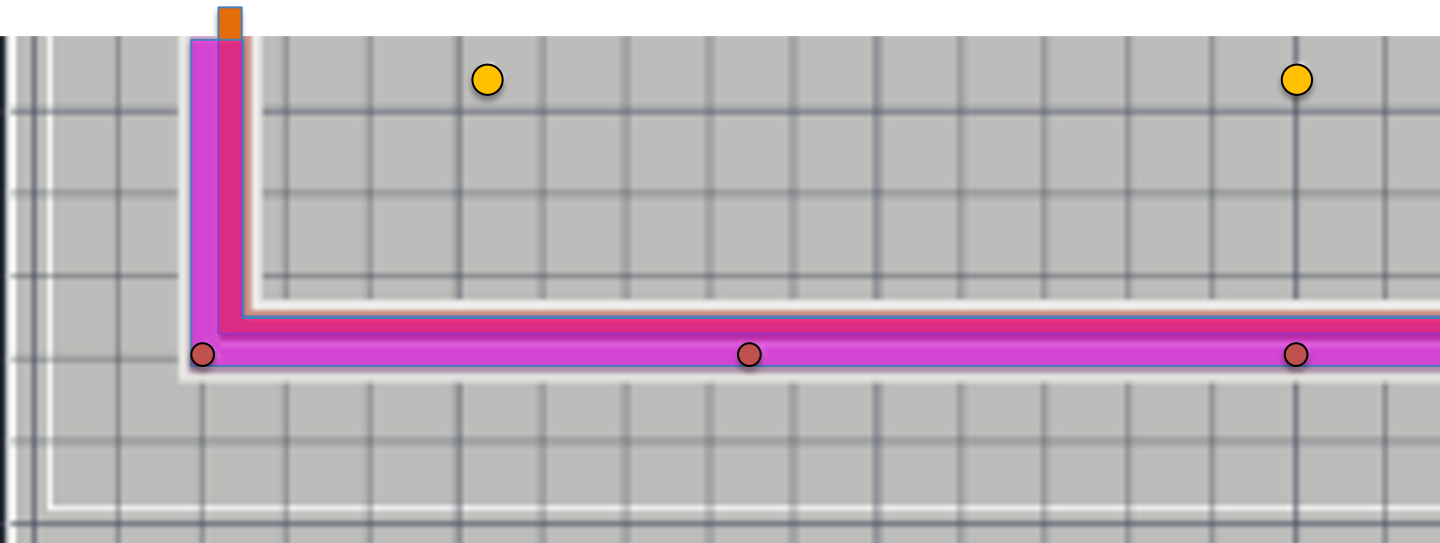
프레임 측면에 IDC cable  
connection을 위한  
feedthrough 설치 (4\*2=8 / set)



# 측면에서 바라 본 모양 (프레임에 널 탭 구멍)

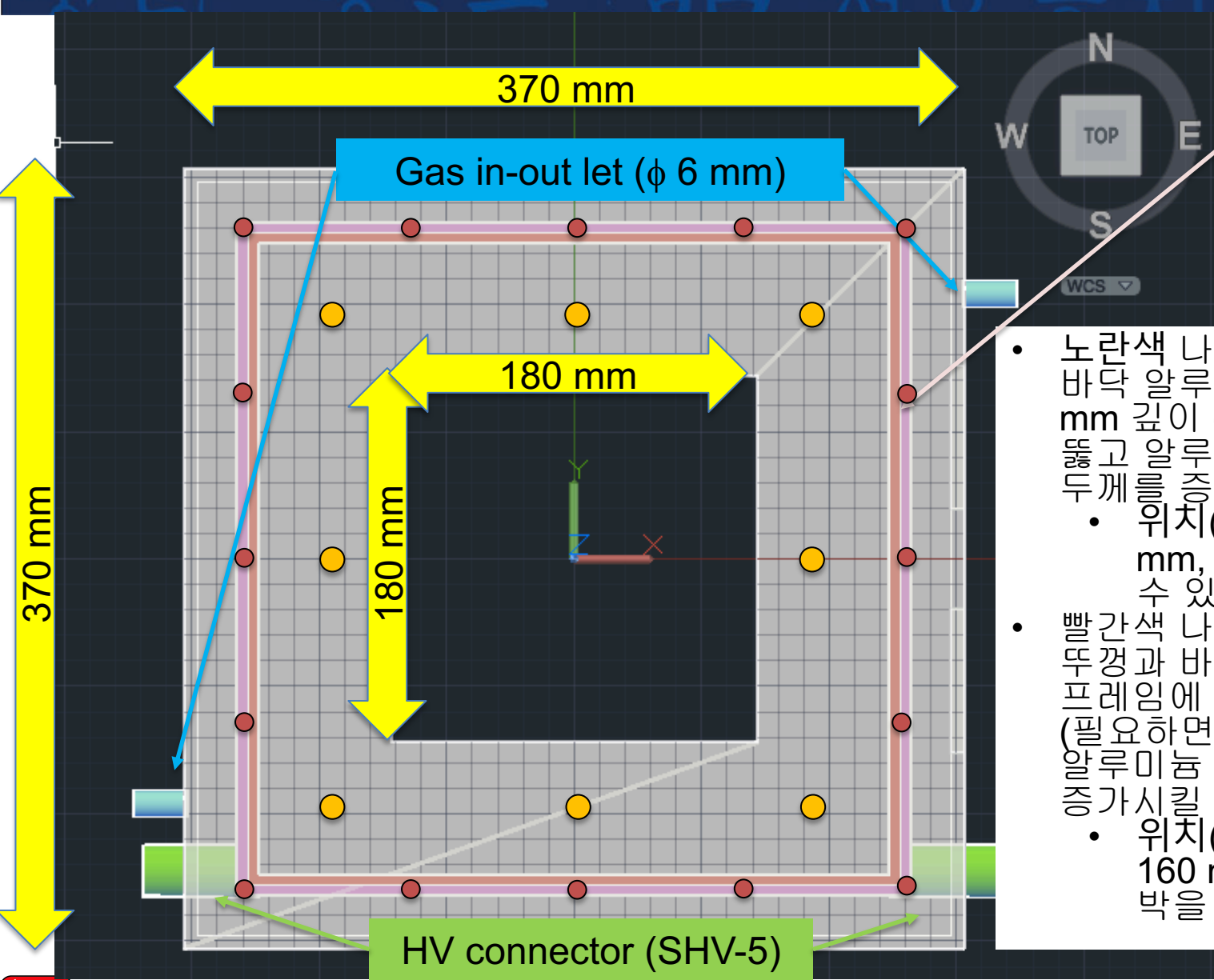


- 빨간색 나사 부분 - 뚜껑, 바닥 모두 프레임에 3 mm 깊이로 뚫기 (깊이 조정 가능)
- 구멍 위에 5 T 두께, 사각틀 모양의 아크릴(또는 비절연성 재질) spacer 를 대고 위에서 나사로 고정 예정





# 뚜껑 위에서 내려다 본 모양 (나사 구멍 위치)

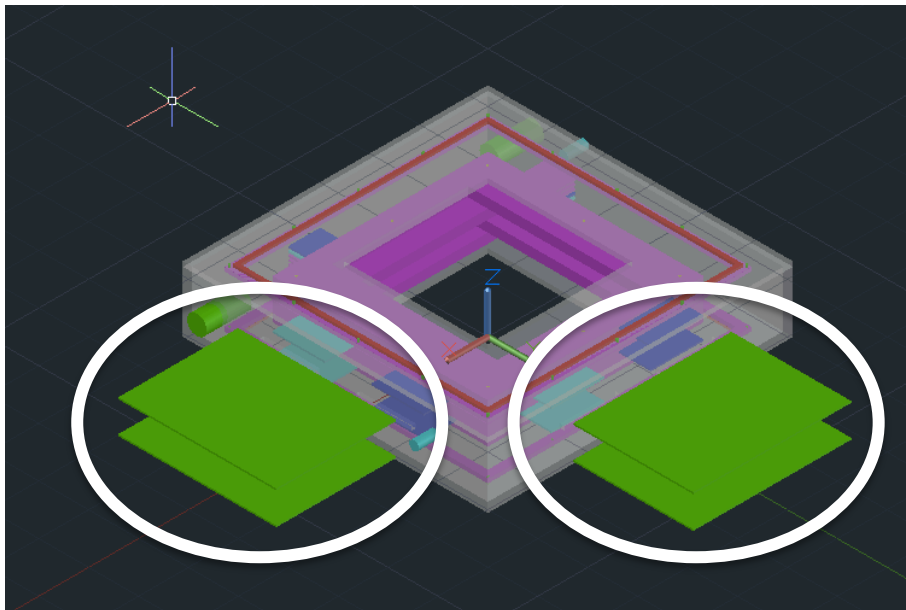


오링과 5T 두께의 스페이서

- 노란색 나사를 박을 구멍 - 바닥 알루미늄 프레임에 3 mm 깊이 (필요하면 더 깊이 뚫고 알루미늄 프레임 두께를 증가시킬 수도 있음)
  - 위치(x, y 축 기준 120 mm, 3T짜리 나사 박을 수 있는 구멍)
- 빨간색 나사를 박을 구멍 - 뚜껑과 바닥 알루미늄 프레임에 3 mm 깊이 (필요하면 더 깊이 뚫고 알루미늄 프레임 두께를 증가시킬 수도 있음)
  - 위치(x, y 축 기준 80, 160 mm, 3T짜리 나사 박을 수 있는 구멍)

# 기판 지지대

- 2개 측면에 2개 보드를 메인 프레임에 지지대를 이용하여 고정
- 구조는 연결할 각종 커넥터와 구멍을 막지 않으면 어떤 것이든 가능함



## 시제품용 기판 지지 방식

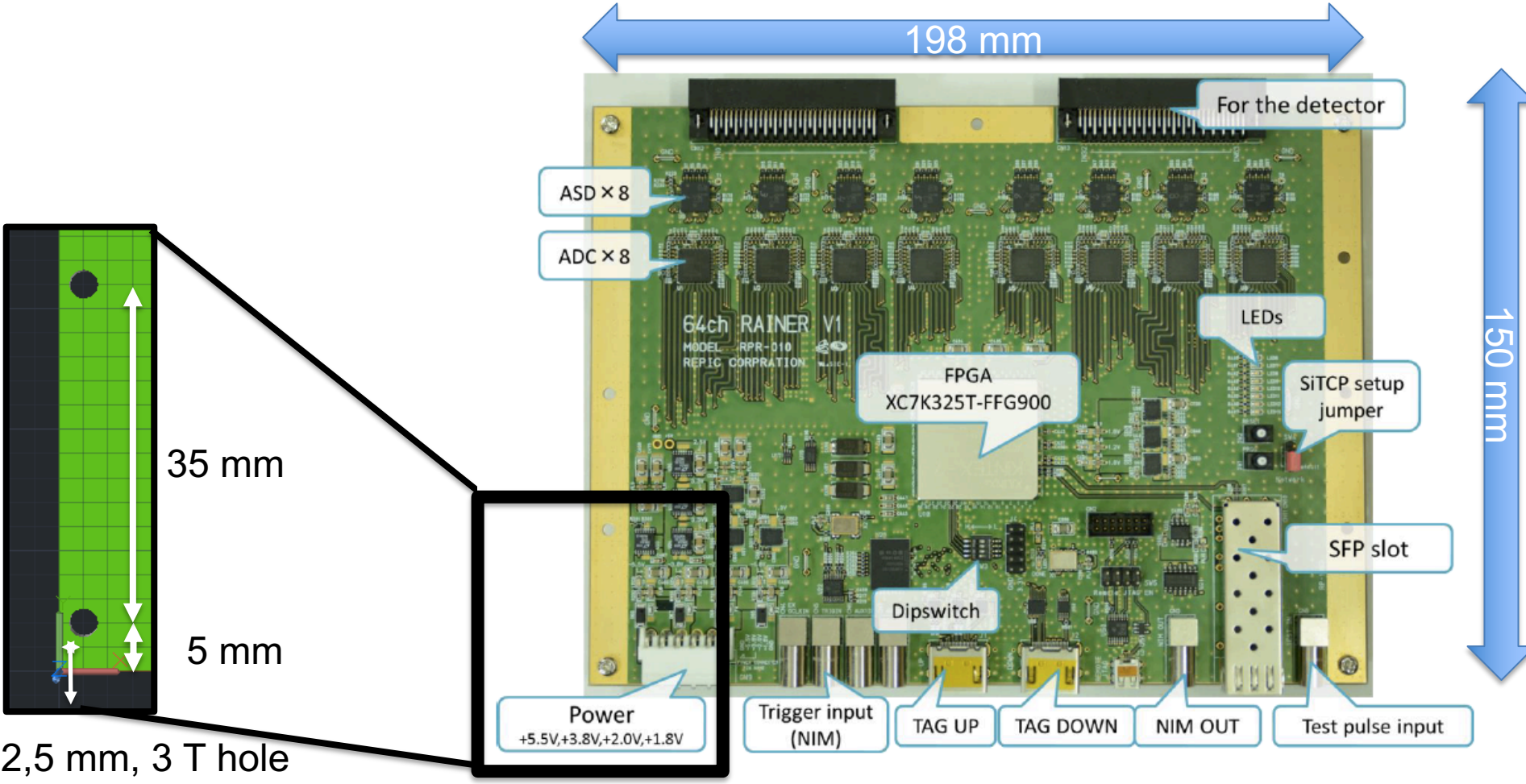
- cosmic muon test까지 가능하도록 프레임에 세워서 지지하는 방식으로

## 본제품용 기판 지지 방식

- If 기판이 0.2-0.3 T의 magnetic field와 진공 환경에서 동작이 가능하다면 (Anyone have answer?)
  - Y : vacuum chamber 안에 위치(보드와 검출기의 거리는 가까워야 함), 보드는 눕히는 방식으로 공간 최소화
  - N : ASD 보드는 vacuum chamber 외곽에 위치해야 함

# 고정 시킬 기판의 정보

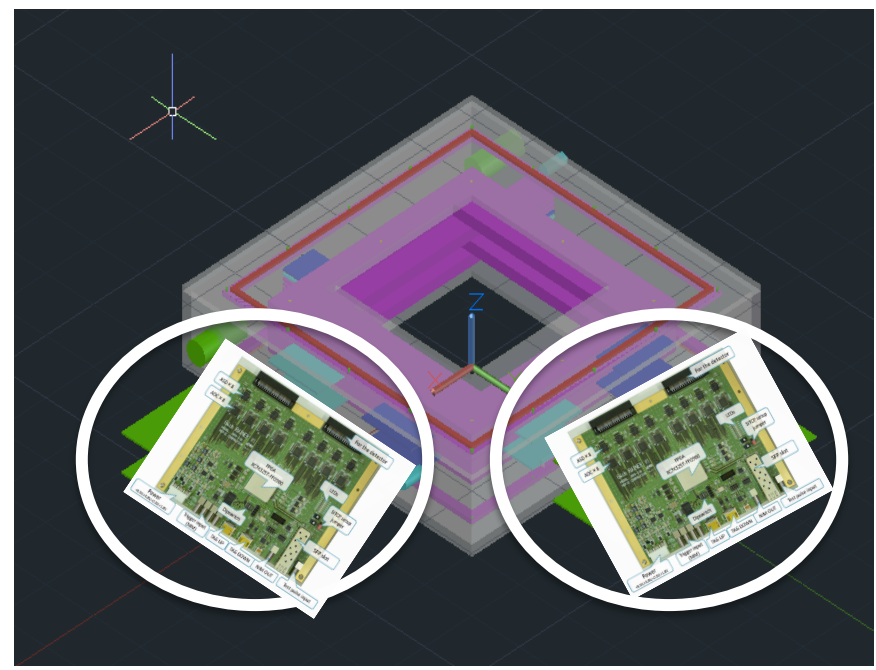
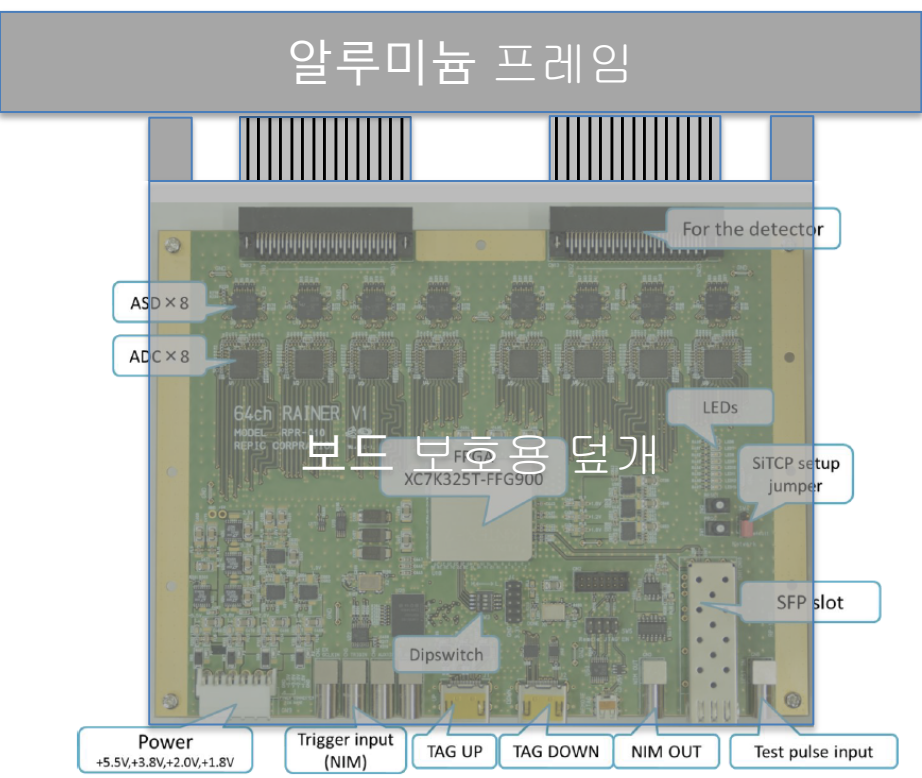
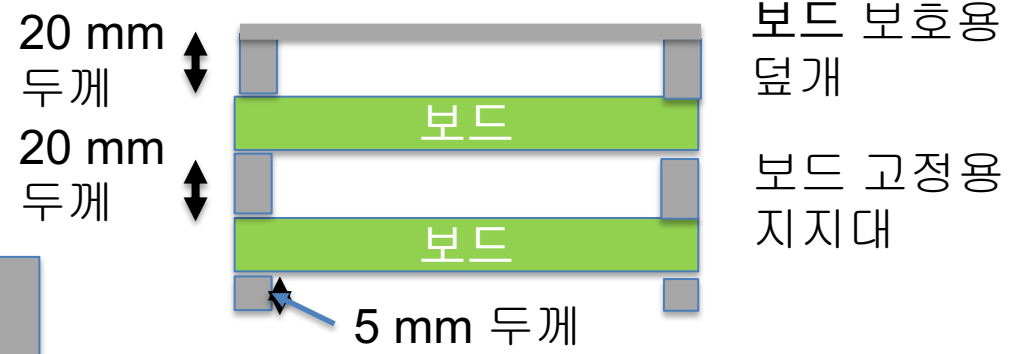
- 두 측면에 이런 기판을 2층으로 고정해야 하고,
- 기판 사이 20 mm 이상의 차이는 뒤야 함





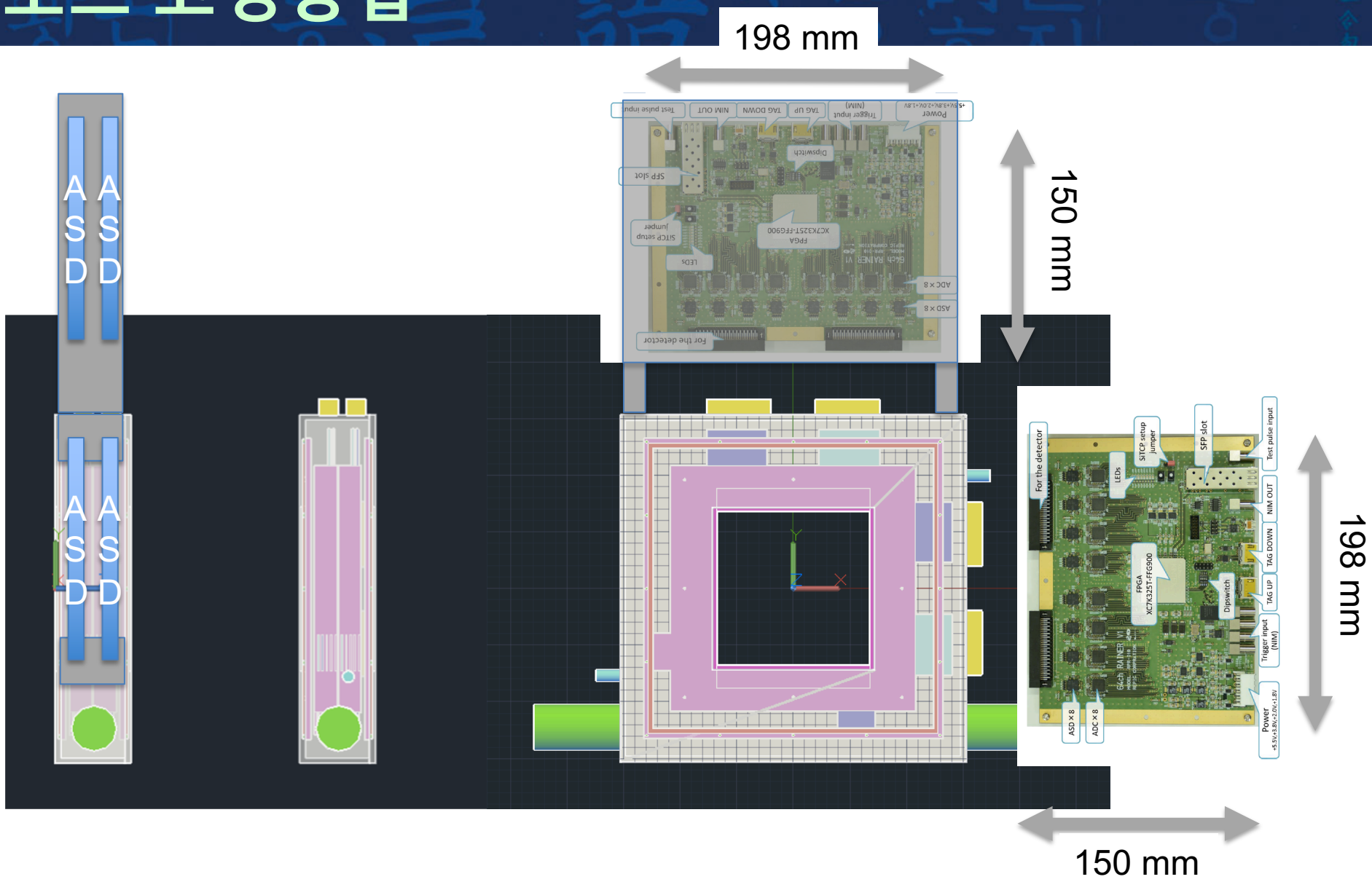
# 기판 지지대

- 보드의 **IDC** 커넥터가 프레임에 가까운 쪽으로 향해 있어야 함





# 보드 고정방법



# 예산 견적 내용

## 총 1억 5000 만원 예산

### BDC 본제품 제작을 위한 견적서

No.1	품 명 및 규 격	단위	수량	단 가	금 액	비고(발주처정보)
1	outer frame (내부 wired chamber 제외) -400mm*400mm*100H (15T) -Chamber Wall electro polishing -.설계및 제작 -.Vacuum Test Flange -.SHV CF1.33", DC5KV10A -.SUB-D ,37pin -.outside Plug & inside Plug Chamber 제작을 위한 각종 잡자재 및 인건비	식	2	20,000,000	40,000,000	영하이테크 (백병창 : 042-635-2845)
2	ASD boards - 총 4개 소요, 3개 추가 주문(여분 1개)	개	7	10,000,000	70,000,000	Hayashi-Repic Co., LTD. <a href="https://www.h-repic.co.jp">https://www.h-repic.co.jp</a>
3	chamber 거치대	식	2	2,500,000	5,000,000	영하이테크 (백병창 : 042-635-2845)
4	와이어(길이 270 m), 운송비 포함 - Signal : Au coated Tungsten (20 micron) - Potential : Au coated Aluminium (80 micron)		1	2,500,000	2,500,000	California Fine Wire company <a href="https://calfinewire.com/request-quote/">https://calfinewire.com/request-quote/</a>
5	anode, cathode planes, spacers - anode : xy, x'y' 각 8매 이상 - cathode : 18매 이상 - spacer : 0.5 mm 간격 35매 이상			2,000,000	2,000,000	이룸테크 (임도진 : 02-3281-2484)
6	Metalized mylar				1,600,000	G-Tech Corp. (Japan) <a href="mailto:goto@ggg-tech.co.jp">goto@ggg-tech.co.jp</a>
7	HV module (CAEN N 1471 HET)		1		8,000,000	오토텍 <a href="http://atkinc.com/Introduction">http://atkinc.com/Introduction</a>
8	LV modules	개	2	700,000	1,400,000	엘레파츠 <a href="https://www.eleparts.co.kr/main/index">https://www.eleparts.co.kr/main/index</a>
9	유량자동조절시스템	식	1	15,000,000	15,000,000	영하이테크 (백병창 : 042-635-2845)
10	각종 소형 부품 등 잡비용 - 기관 고정용 부품들 - Electronics까지 연결할 케이블 - 데이터 처리를 위한 DAQ 장비 등				4,500,000	
	소 계				150,000,000	VAT포함

Need 5 more

# Hopeful plan for next

- Aug. 3<sup>rd</sup> : Order the outer frame, DAQ code check
- Aug. 4<sup>th</sup> : Assemble the inside chamber with 4 anode layers (KRISS)
- Sep. 1<sup>st</sup> : Assemble outside frame
- Sep. 2<sup>nd</sup> : Test with cosmic muons, try to wiring 4 anode planes
- Sep. 3<sup>rd</sup> : Try to wiring 4 anode planes
- Sep. 4<sup>th</sup> : Try to wiring 4 anode planes
- Oct. 1<sup>st</sup> : Assemble the second set + test
  
- Will continue, if we could

BDC crews are doing the best for the detector with good performance! Stay tuned!

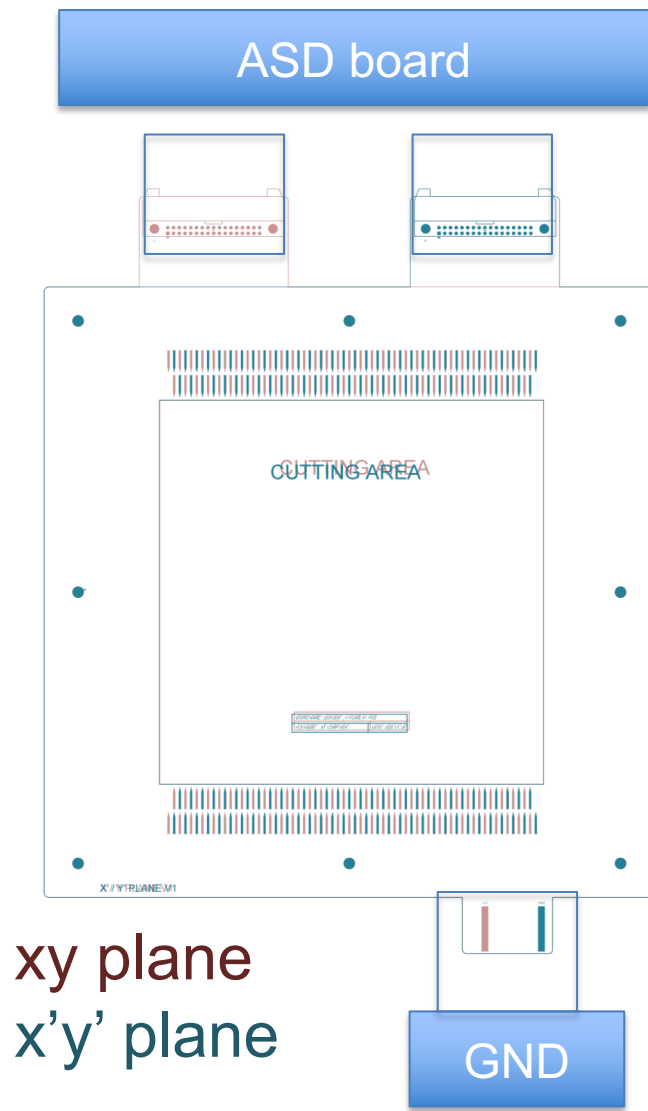
지금이라도 시간과 예산을 조금만 더 주시면..  
변명은 죄악이라고 말했을텐데, 니트로박사

Animation, Montana Jones

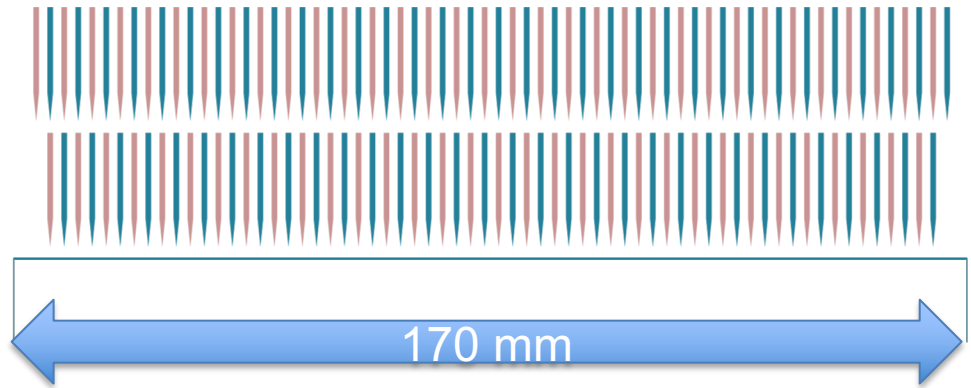
# Supplement materials



# Design of anode planes



Drift length : 2.5 mm

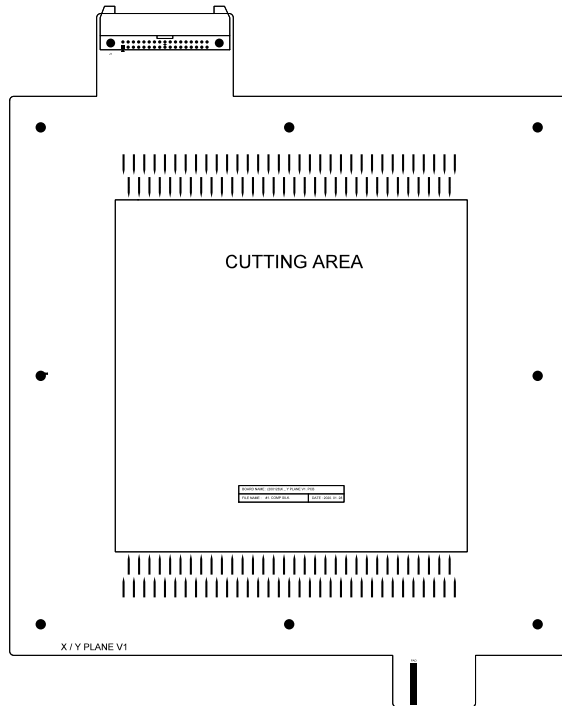


xy plane is shifted from x'y' plane  
with 2.5 mm spacing

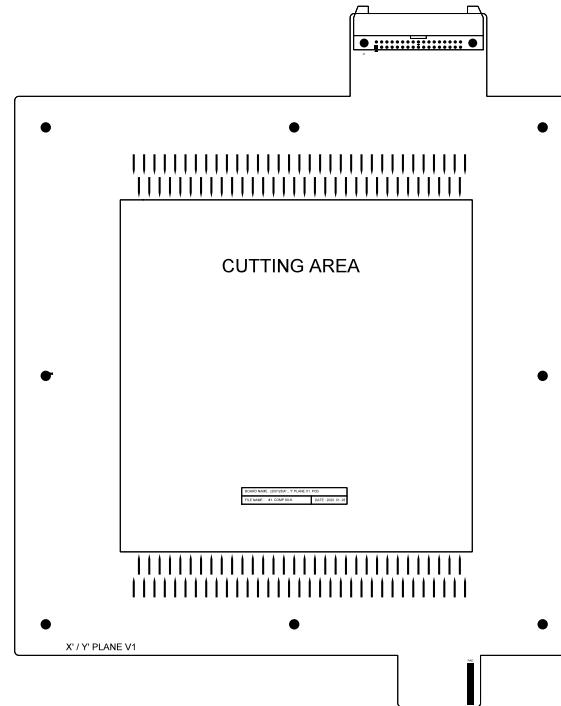
Designed by Sanghoon Hwang

# Design of prototype BDC

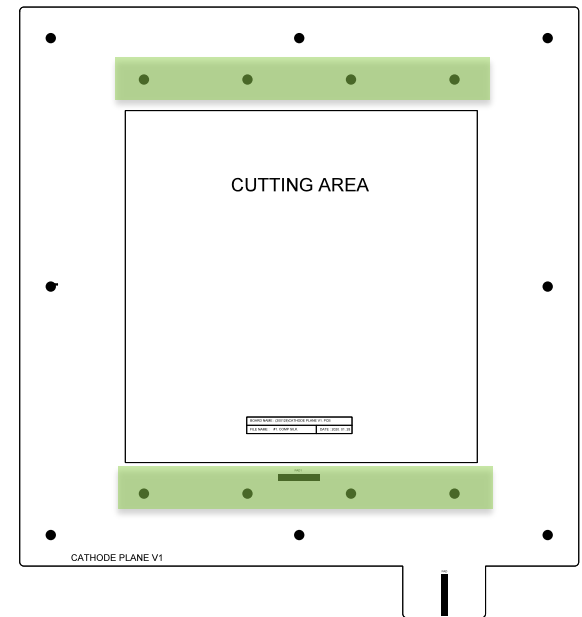
xy plane



x'y' plane



cathode plane



Holes for gas circulation

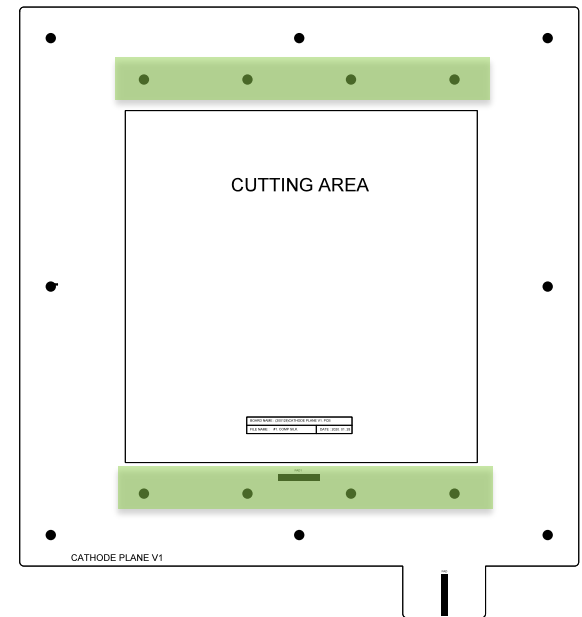
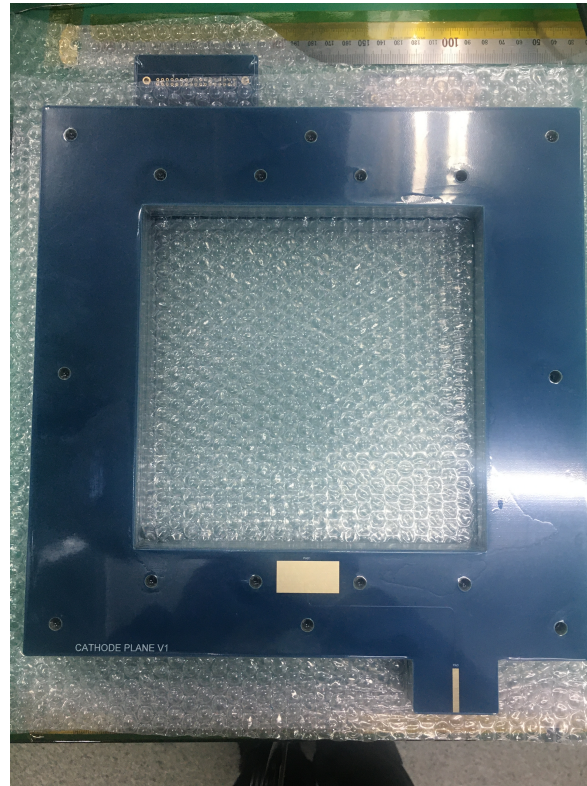
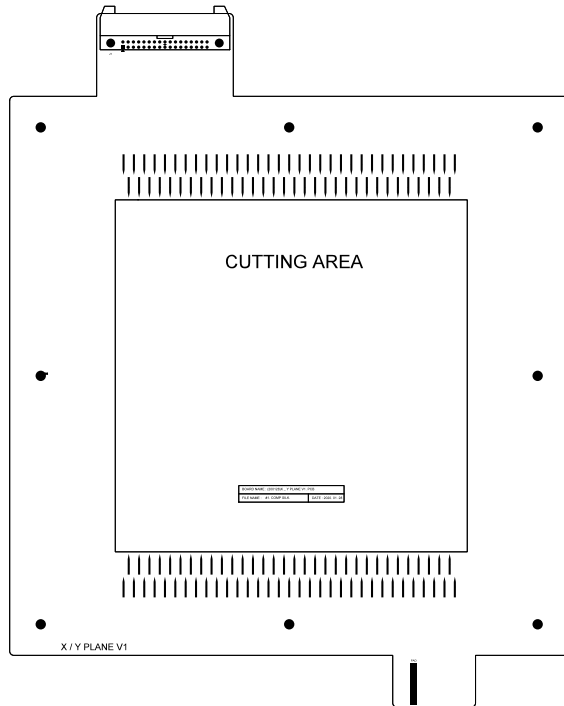
Designed by Sanghoon Hwang

Gas가 순환하는데 이 구멍이면 충분한가?

# Design of planes

R : 1.5 mm

cathode plane



Holes for gas circulation

Designed by Sanghoon Hwang

Q) Gas가 순환하는데 이 구멍이면 충분한가?

# Applied gas to chamber

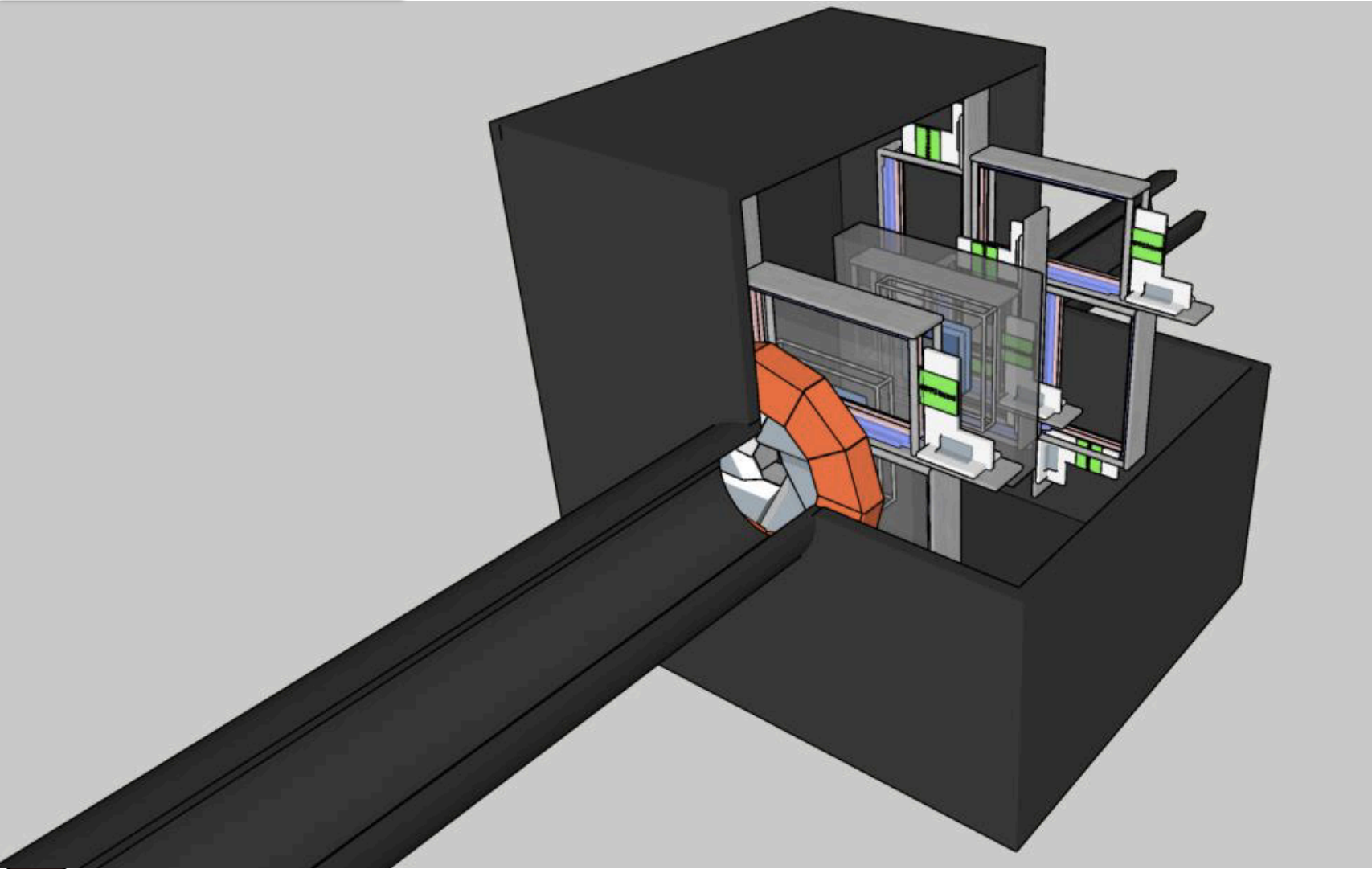
- P-10 mixed gas
- Pressure : 100 torr (same as the pressure inside the vacuum chamber)
- Needed volume
  - Volume inside BDC :  $37*37*7 \text{ cm}^3 = 9.583 \text{ L}$
  - Structure's volume (planes) = 2.288 L
  - Estimated gas volume : 7.3 L / set
  - Circulation rate : ~ 200 mL / minutes (~ 300 mL / min in initialization step)
    - ~ 35 minutes / 1 circulation



# New version of LAMPS design (이형준)

Vacuum chamber

Cylindrical shape -> rectangular shape



# Setup for wiring in clean room, KRISS

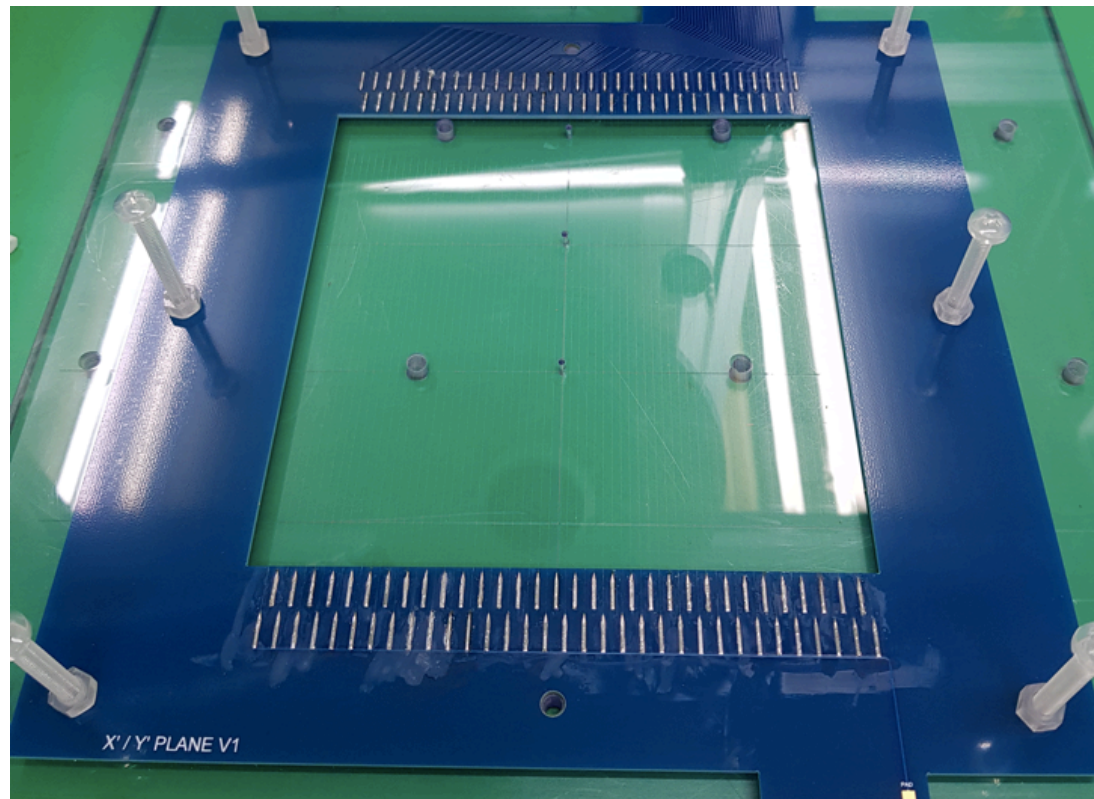
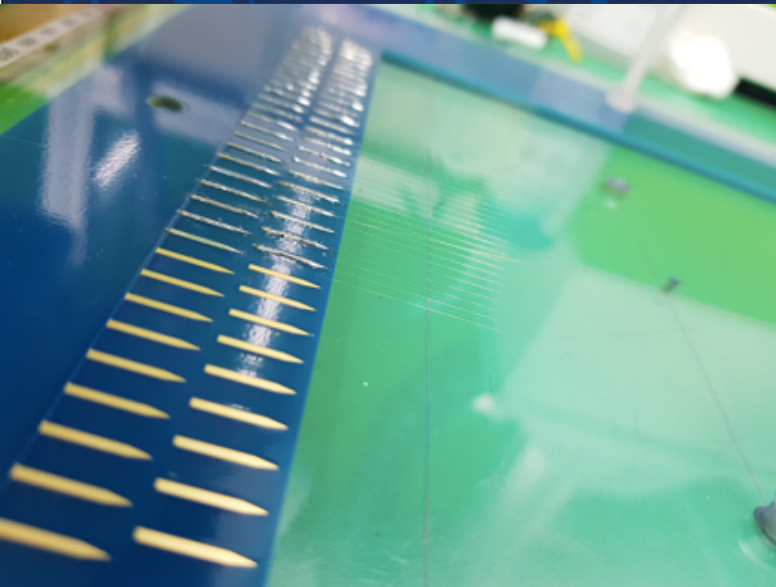
- Jaein (undergraduate student) worked at KRISS in Feb. 10-14



Wire thickness :  $16 \mu\text{m}$   
Gold coated tungsten wires  
for signal and potential wires



# Plane after wiring

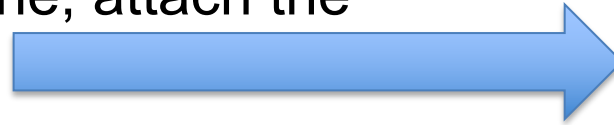


Wiring is done in 1 xy plane and 1 x'y' plane

# Next step for prototype BDC

- **Cleaning and assembly chamber**

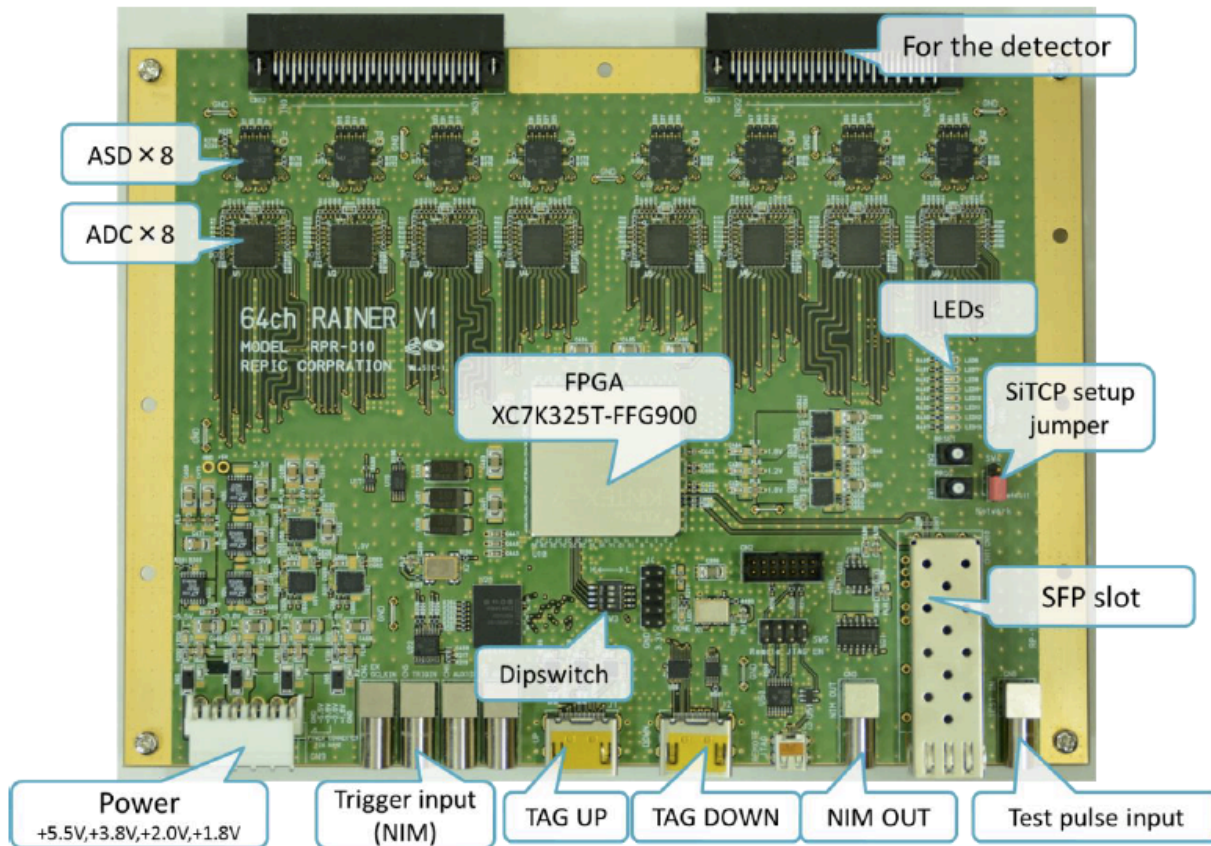
- Clean wired planes in the machine
- On the cathode plane, attach the metalized mylar
- To keep 2.5 mm spacing between mylar and wires, attach the spacer (0.5 mm thickness)
- And assembly chamber for the test
  - Cathode-xy plane-Cathode-x'y' plane-Cathode



- **Hope to continue in next week..**



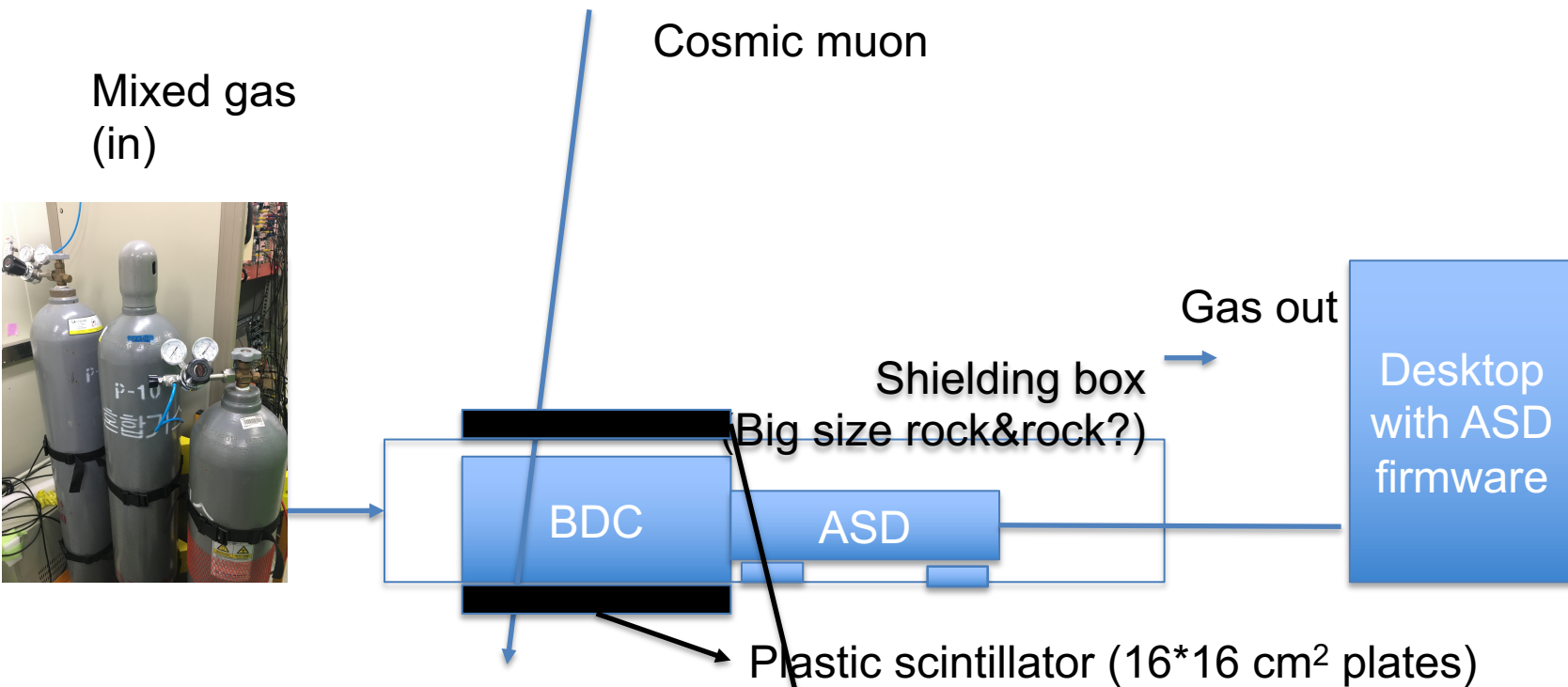
# Preparation of ASD board test



- Power input connector : S6P-VH
- 6 wires should be connected (GND, +5.5V, +3.8V, +2.0V, +1.8V, GND), Maximum current : 5A
- 2 \* 2 channel power supply are needed
  - 1 from KRISS, 1 will be ordered



# (Preliminary) setup of the prototype BDC test



- Continue to discuss about the setup